

INSIGHT SKYTECH

天虹科技
SKYTECH

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Management Team & MFG Locations

■ INFO

Stock Symbol : **6937**
 Establish Date : **2002/07**
 Capital : **TWD 675,762,630**
 Employees : **424**



Homestead (~2021)



Paul Huang
 Skytech Chairman



Carl Lo
 Skytech founder & Vice President



George Yi
 Skytech CEO
 (Previous AMAT Corporate VP
 for global field service)

■ LOCATIONS

Hsinchu (Headquarter)



Hsinchu MFG#1



(with RD center)

Hsinchu MFG#2



Tainan MFG



SkySemi
 Xiamen MFG



SkySemi
 Shanghai Office



Gimtek
 Singapore Office



JTCK
 Japan Office



(M&A in 2025/10)

Awards

2026 ERSO AWARD



2025 Taiwan FINI 100 Companies



序	公司名稱	營業額 (億元)	研發投入 (億元)	研發投入占營業額 (%)	研發人員 (人)	研發人員占總員工 (%)	研發人員占總資產 (%)
1	鴻海	2,000.0	1,000.0	50.0	100,000	10.0	10.0
2	聯發科	1,500.0	750.0	50.0	50,000	10.0	10.0
3	台积电	1,200.0	600.0	50.0	40,000	10.0	10.0
4	三星	1,000.0	500.0	50.0	30,000	10.0	10.0
5	SK Hynix	800.0	400.0	50.0	20,000	10.0	10.0
6	三星	700.0	350.0	50.0	15,000	10.0	10.0
7	三星	600.0	300.0	50.0	10,000	10.0	10.0
8	三星	500.0	250.0	50.0	8,000	10.0	10.0
9	三星	400.0	200.0	50.0	6,000	10.0	10.0
10	三星	300.0	150.0	50.0	4,000	10.0	10.0
11	三星	200.0	100.0	50.0	3,000	10.0	10.0
12	三星	150.0	75.0	50.0	2,000	10.0	10.0
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2024 Taiwan Mittelstand Award



The Largest Corporations in Taiwan 2022 TOP 5000



Skytech Patent Summary

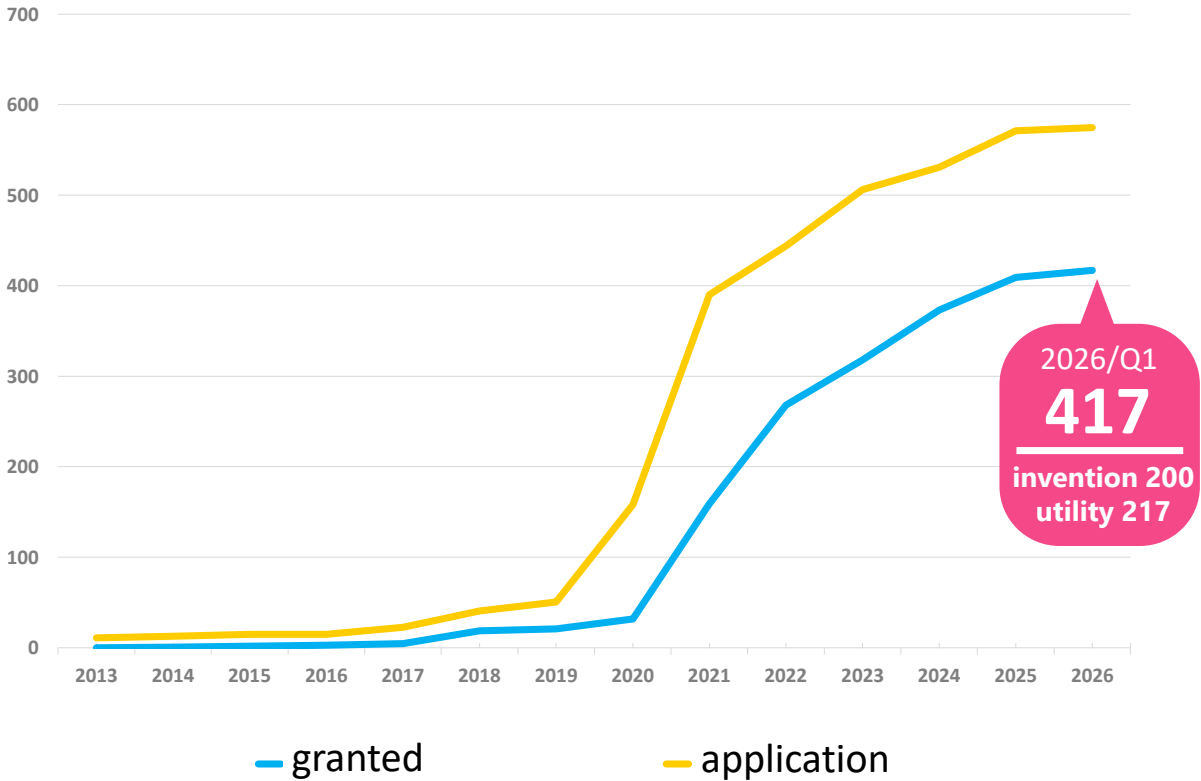
Skytech Inc.
 Total submitted **575**
 Total Patented **417**



Patent	Invention	Utility	Total
Taiwan	104	113	217
China	49	104	153
US	46		46
Singapore	1		1
Global	200	217	417

As of 2026/Q1

Patent Statistics



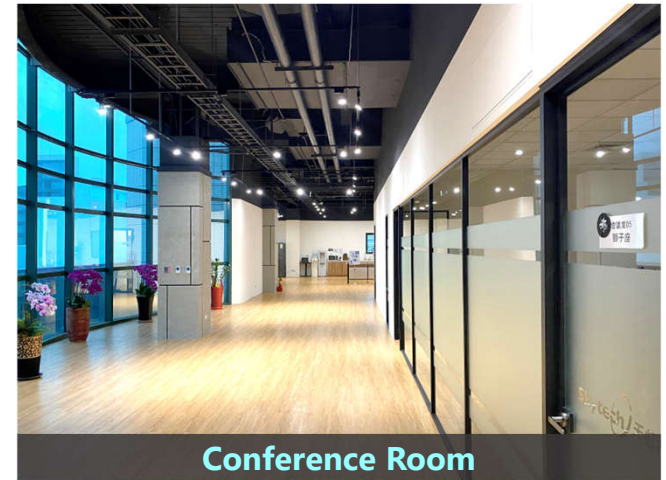
Hsinchu MFG R&D Center



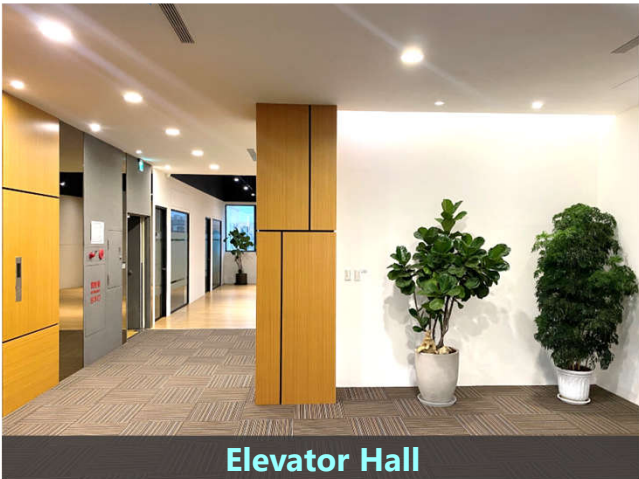
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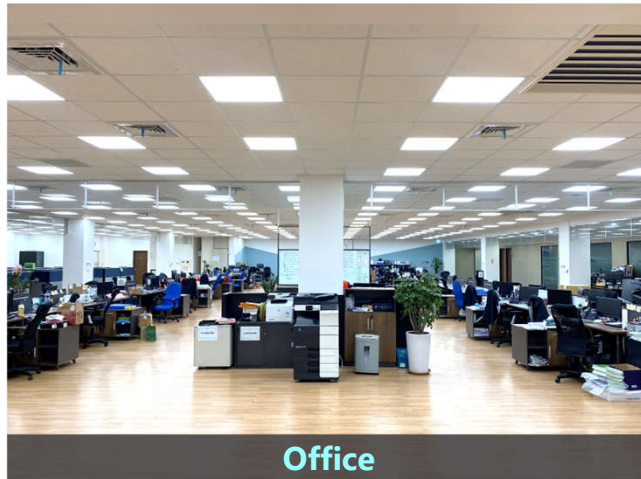
Lobby



Conference Room



Elevator Hall



Office



Pantry Room

Hsinchu MFG 1F Cleanroom



✓
Class10k

Full Bay x8 & Mini Bay x3

✓
Class1K

DEMO Process x3



Hsinchu MFG 3F Cleanroom

✓
Class1K

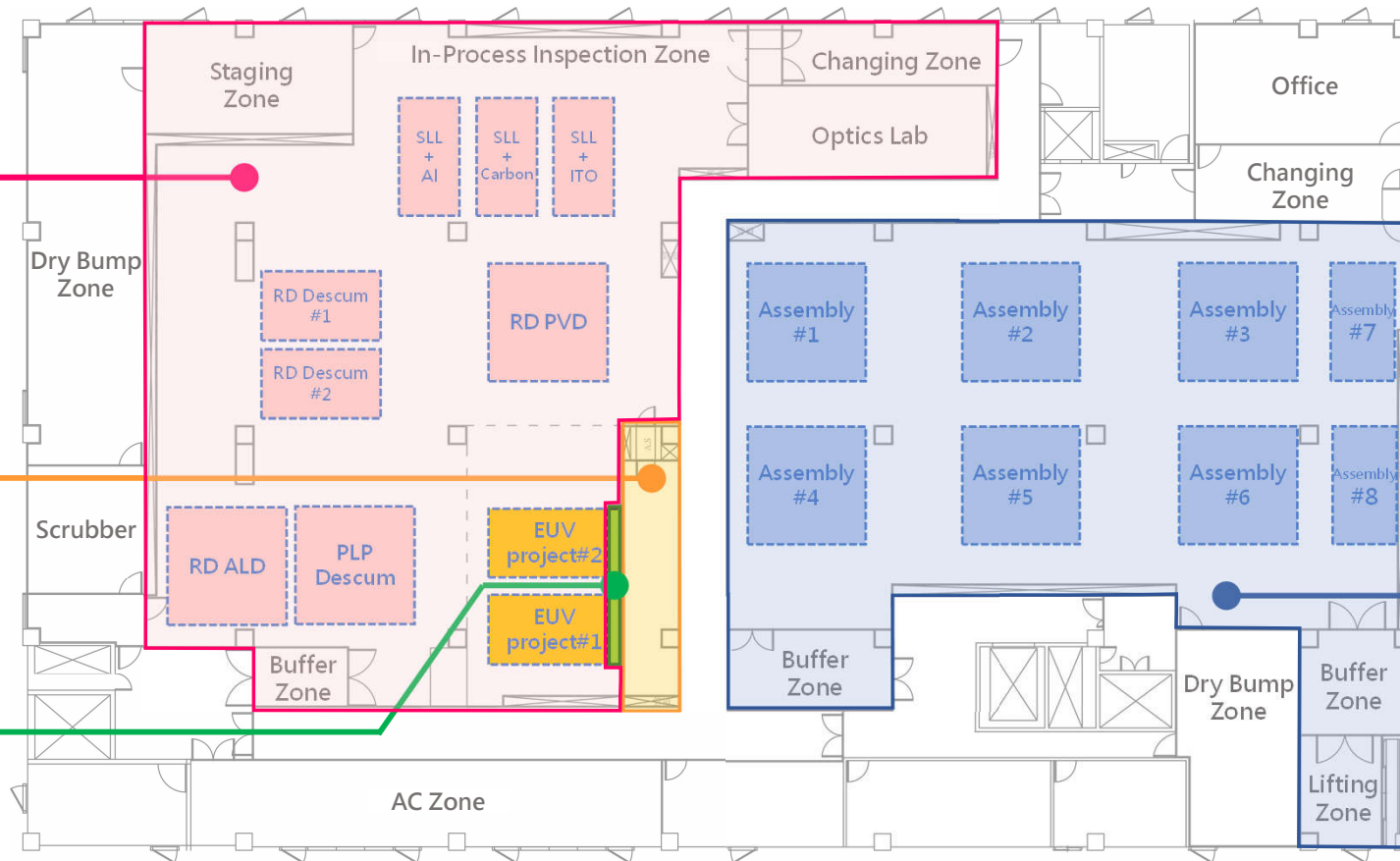
DEMO Process x8

✓
Class100

EUV Project

✓
Class10

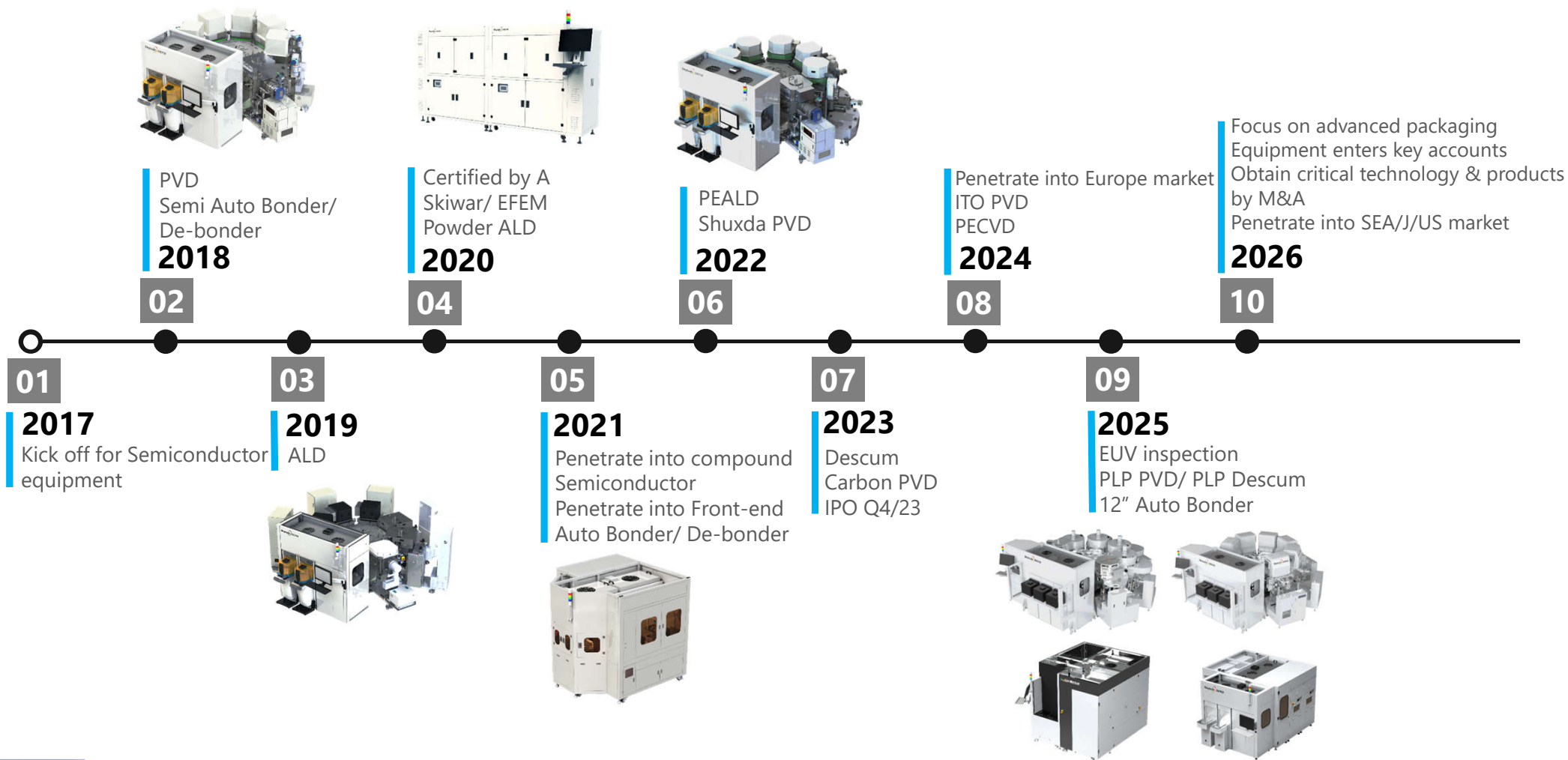
EUV Project



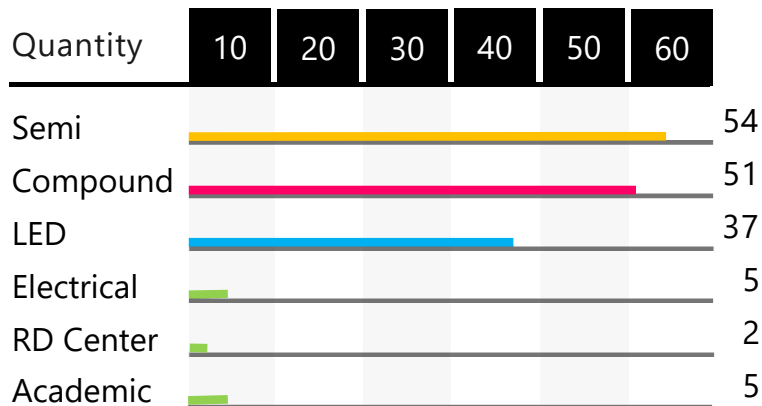
✓
Class10K

Full Bay x6 & Mini Bay x2

Skytech Roadmap



Equipment Delivery Records



Delivery **154** equipment to customers till 2026/Q1



Achieved sales milestone of the 100th system delivery on 2024/06/28

Quantity	Category	Ship Date	Quantity	Category	Ship Date	Quantity	Category	Ship Date	Quantity	Category	Ship Date
1	Compound	2018/5/22	40	LED	2022/3/15	79	Semi	2023/9/8	118	LED	2024/12/10
2	Compound	2018/5/22	41	Semi	2022/4/30	80	Semi	2023/10/4	119	Semi	2024/12/18
3	Semi	2018/6/1	42	Semi	2022/6/30	81	Compound	2023/10/10	120	Semi	2024/12/23
4	LED	2018/6/7	43	LED	2022/7/5	82	Compound	2023/10/10	121	Semi	2024/12/23
5	LED	2018/8/15	44	LED	2022/7/7	83	Compound	2023/10/11	122	Semi	2025/2/8
6	LED	2018/9/4	45	Compound	2022/7/15	84	Semi	2023/10/18	123	Semi	2025/3/25
7	Compound	2018/12/30	46	Compound	2022/7/15	85	Compound	2023/12/13	124	Semi	2025/3/25
8	Compound	2018/12/30	47	Compound	2022/8/1	86	Semi	2023/12/29	125	LED	2025/3/27
9	Semi	2019/4/11	48	RD Center	2022/9/20	87	Compound	2024/1/2	126	Semi	2025/4/24
10	Compound	2019/7/4	49	Compound	2022/9/23	88	Compound	2024/1/2	127	LED	2025/5/12
11	Semi	2019/9/16	50	Compound	2022/9/27	89	Semi	2024/2/27	128	LED	2025/6/4
12	LED	2020/5/15	51	Semi	2022/9/29	90	Semi	2024/3/27	129	LED	2025/6/16
13	LED	2020/6/8	52	Compound	2022/9/29	91	Semi	2024/3/27	130	Electrical	2025/6/25
14	LED	2020/6/15	53	Compound	2022/9/29	92	Compound	2024/3/28	131	Compound	2025/6/26
15	Compound	2020/6/15	54	LED	2022/12/4	93	Compound	2024/3/28	132	Semi	2025/8/19
16	Semi	2020/7/20	55	Semi	2022/12/14	94	Semi	2024/3/29	133	LED	2025/8/27
17	LED	2020/7/31	56	Compound	2022/12/28	95	LED	2024/5/29	134	Semi	2025/9/8
18	LED	2020/7/31	57	Compound	2022/12/28	96	Semi	2024/6/6	135	Electrical	2025/9/30
19	LED	2020/8/14	58	LED	2022/12/29	97	Semi	2024/6/12	136	Compound	2025/10/2
20	Compound	2020/8/31	59	Compound	2023/1/5	98	Compound	2024/6/24	137	LED	2025/10/3
21	LED	2020/10/8	60	Compound	2023/1/6	99	Compound	2024/6/25	138	Semi	2025/10/13
22	Semi	2020/12/31	61	Compound	2023/2/2	100	Semi	2024/6/28	139	Compound	2025/11/18
23	Semi	2020/12/31	62	Semi	2023/2/8	101	Semi	2024/7/31	140	Semi	2025/12/15
24	LED	2021/2/25	63	Semi	2023/2/15	102	Semi	2024/7/31	141	Semi	2025/12/15
25	Semi	2021/3/15	64	Semi	2023/2/15	103	Semi	2024/8/1	142	Semi	2025/12/18
26	Compound	2021/3/31	65	Semi	2023/3/2	104	Semi	2024/8/1	143	Compound	2025/12/19
27	Electrical	2021/6/30	66	Compound	2023/3/30	105	Academic	2024/8/23	144	Semi	2025/12/22
28	LED	2021/7/12	67	Compound	2023/3/31	106	LED	2024/9/25	145	LED	2025/12/24
29	Semi	2021/11/17	68	Compound	2023/3/31	107	Academic	2024/9/25	146	LED	2025/12/26
30	LED	2021/11/18	69	Semi	2023/5/16	108	Academic	2024/9/25	147	Semi	2026/1/21
31	LED	2021/12/7	70	Compound	2023/5/31	109	Academic	2024/9/25	148	LED	2026/2/11
32	Compound	2021/11/22	71	Semi	2023/6/8	110	Academic	2024/9/25	149	LED	2026/2/11
33	Compound	2021/11/22	72	Compound	2023/6/15	111	LED	2024/10/7	150	Semi	2026/2/11
34	Compound	2021/11/22	73	Compound	2023/6/19	112	Electrical	2024/10/29	151	Compound	2026/2/24
35	Compound	2021/12/24	74	Compound	2023/6/20	113	LED	2024/11/19	152	Semi	2026/3/31
36	Electrical	2021/12/25	75	RD Center	2023/7/3	114	LED	2024/11/28	153	Compound	2026/3/31
37	Semi	2022/1/5	76	Compound	2023/8/16	115	LED	2024/12/4	154	Compound	2026/3/31
38	Semi	2022/2/24	77	Semi	2023/8/31	116	Compound	2024/12/10			
39	LED	2022/2/9	78	Semi	2023/9/6	117	Compound	2024/12/10			

Core Competence & RD Direction

High Vacuum Plasma & Wafer Thinning Solution Provider



**High Vacuum
& Plasma**



PECVD



PVD



ALD



**Descum &
Plasma Polish**



**PLP PVD/
PLP Descum**



**High Vacuum
& Laser**



EUV Inspection



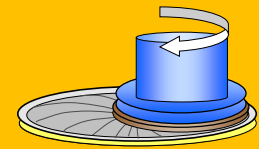
Silicon Semiconductor
Frontend/Adv. Package/IGBT BM
(PVD, ALD, Bonder, Descum, PECVD)

Compound Semiconductor
GaAs/InP/SiC/GaN
(PVD, ALD, Bonder, De-Bonder)

LED/Mini LED/ Micro LED
(PVD, ALD) & (QD Solution)

CPO (Co-Package Optics)
(Bonder, De-Bonder, PVD)

PLP (Panel Level Package)
(PVD, Descum, Etching)



Wafer Thinning

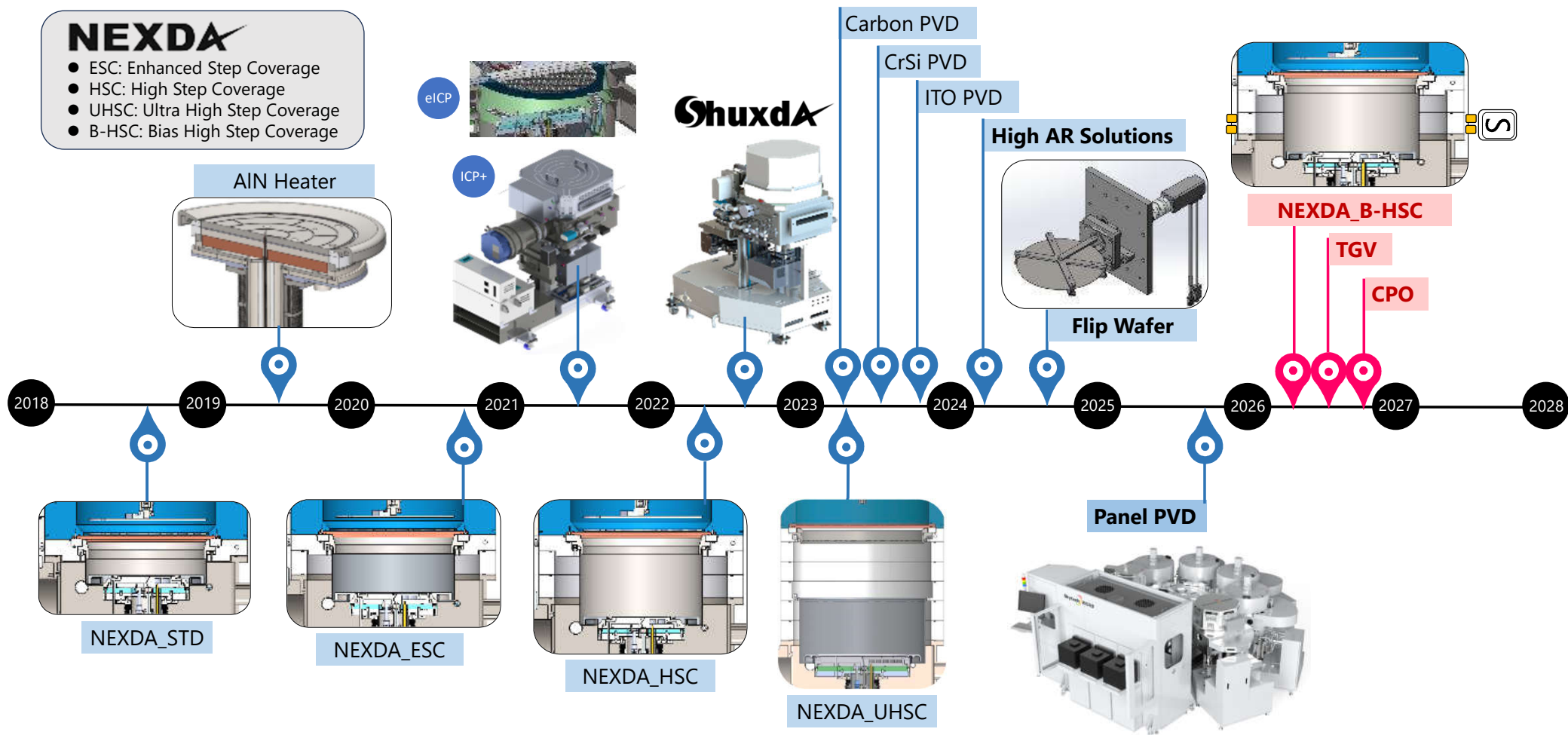


Bonder



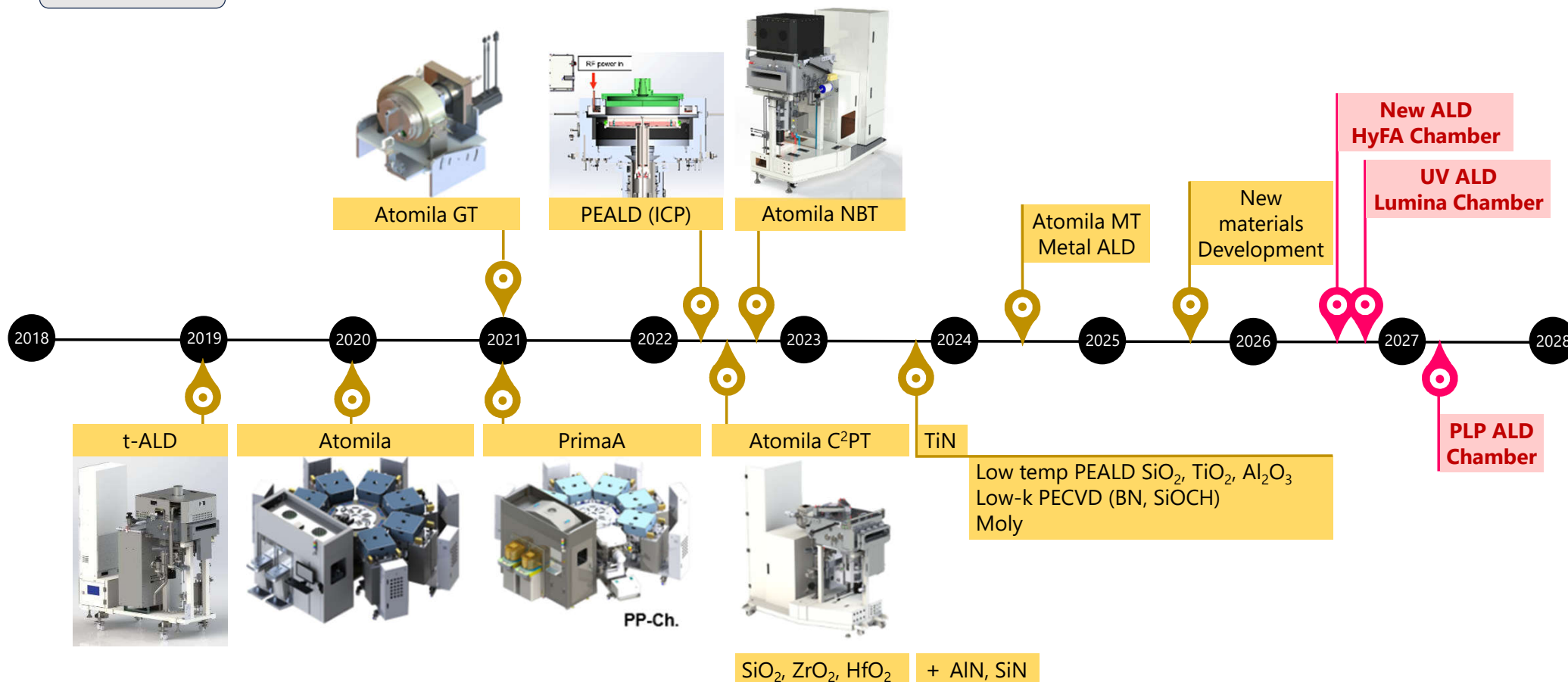
De-Bonder

Roadmap of PVD



Roadmap of ALD

Atomila



Roadmap of Bonder/ De-Bonder

Bondela

CatapultA



4" / 6"
Temporary Bonder
& De-Bonder

8" Temporary Bonder/ De-
Bonder for 8" SiC power device

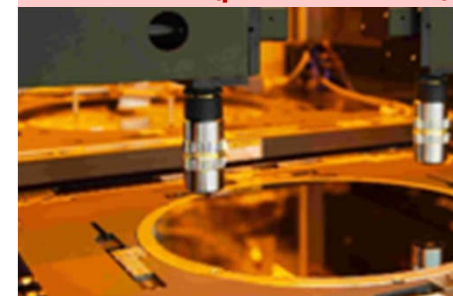


12" Mechanical De-Bonder

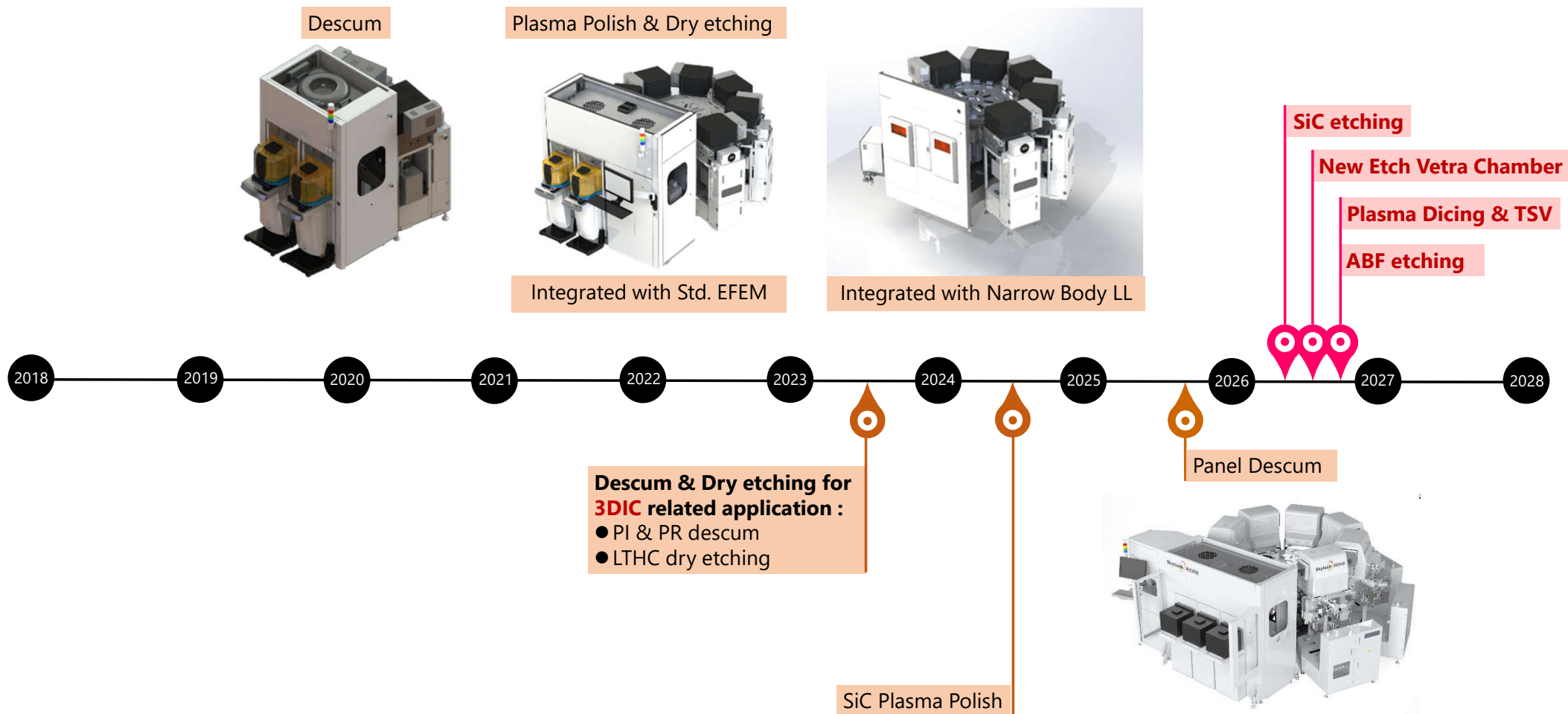


12" Temporary Bonder/ De-Bonder
for advanced package with high
warp. wafer handling capability

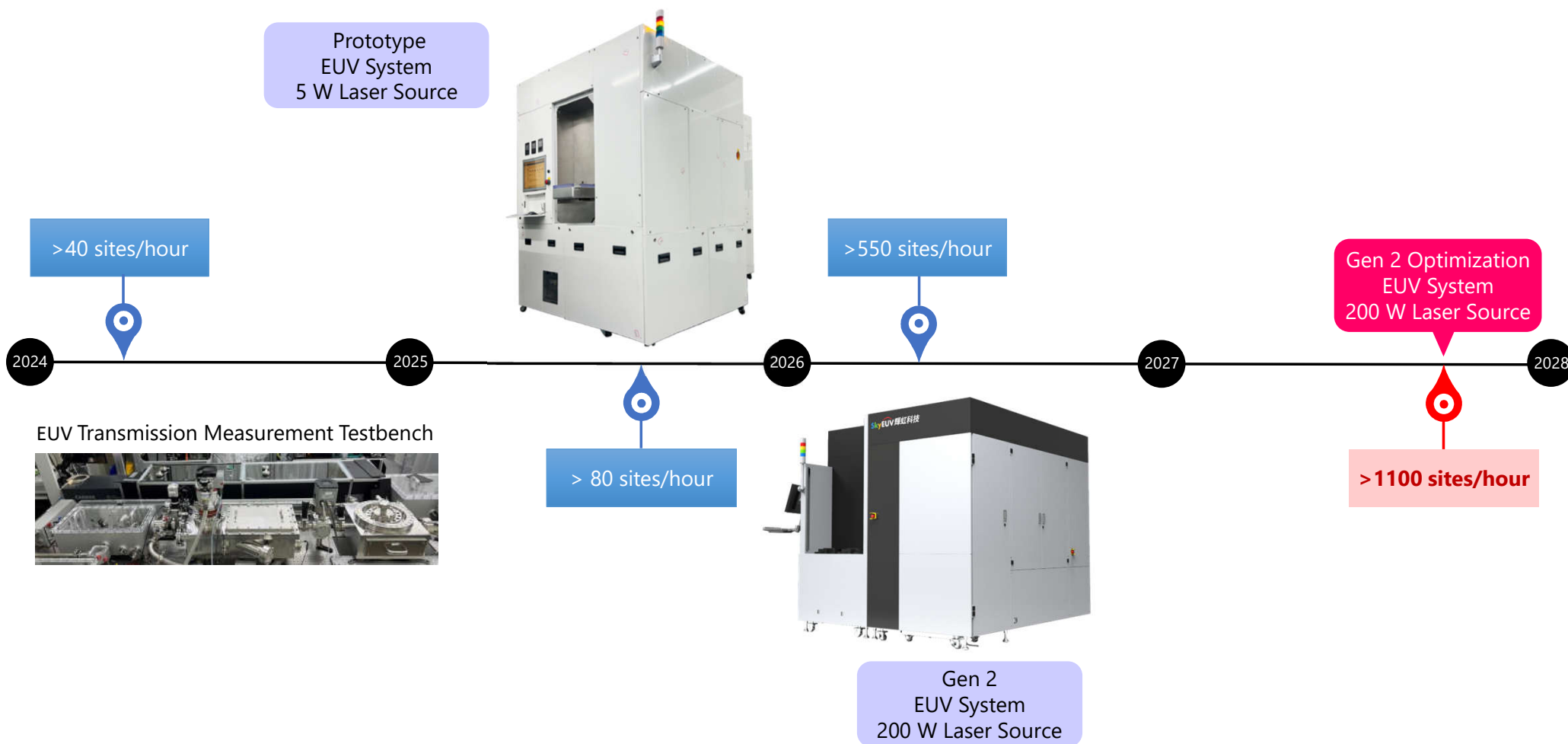
W2W Bonder (permanent bond)



Roadmap of Etching



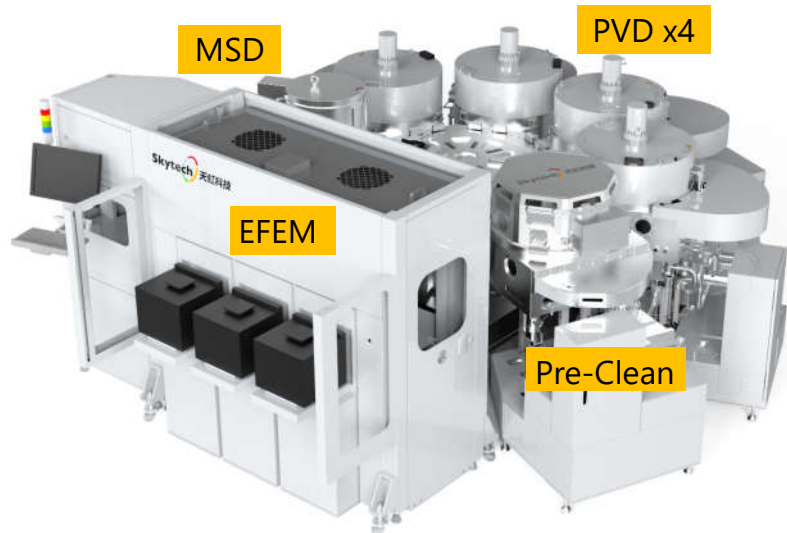
Roadmap of EUV Inspection



Development Plan for PLP Tools

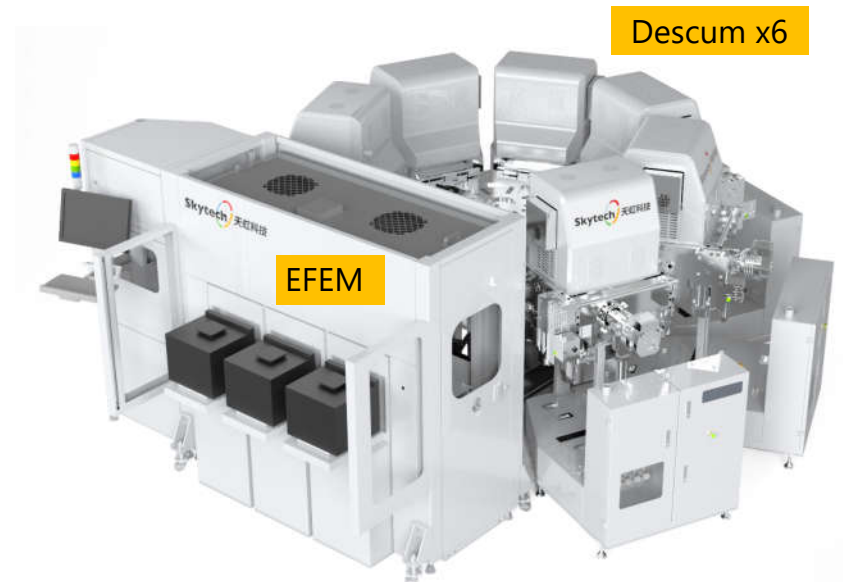
■ PVD Deposition

- **FSM Ti/Cu Deposition:**
LLA → MSD (Multi-Slot Degas) → Pre-clean → PVD
Ti → PVD Cu → LLB
- **BSM Al/Ti/NiV/Au Deposition:**
LLA → MSD (Multi-Slot Degas) → Pre-clean → PVD
Al → PVD Ti → PVD NiV → PVD Au → LLB
 - Multi-Slot degas for MC substrate baking



■ Descum

- **Maximum 6 Descum chambers, 6 process gases**
- Microwave on top (provided top RPS), & CCP at bottom, with dual plasma capability



[illegible]PLP PVD System
Semi S2 Certification



Achievement

- Successfully delivered the first 310x310mm PLP PVD system with a strategic customer, securing a 2nd customer order.
- ALD gains momentum in advanced technologies and smart glasses applications.
- Next-gen EUV transmission inspection tool (EUV2) hits performance targets, outperforming EUV1 prototype.



Challenge

- Manufacturing bay management with the most effective way.



On-going project

- Continue engagement in advanced technologies and advanced packaging.
- Deliver the 12-inch Auto Mechanical De-Bonder, scheduled for Q2 2026.
- Develop the new Lumina UV ALD chamber, scheduled for Q3 2026.
- Develop the new HyFA ALD chamber, scheduled for Q3 2026.
- Develop the new Vetra etching chamber, scheduled for Q4 2026.
- Develop the new 310×310 Panel ALD chamber, scheduled for Q1 2027.
- Develop Nexda 2.0 operation software, scheduled for Q1 2027.
- Continue to execute M&A and investments to drive inorganic growth.

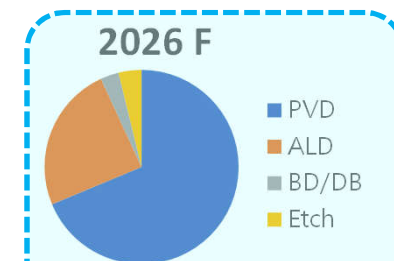
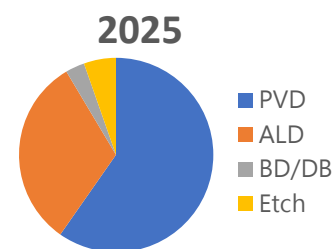
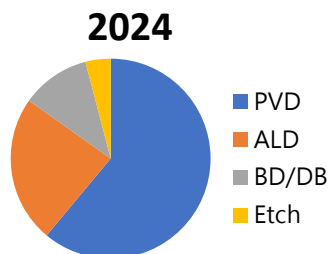
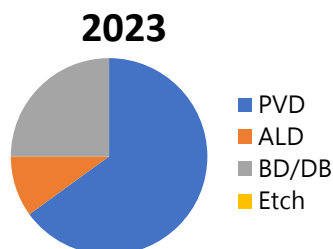
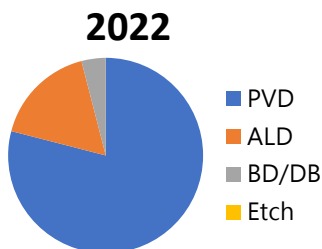
Finance Performance

(Unit: NT\$ thousand)

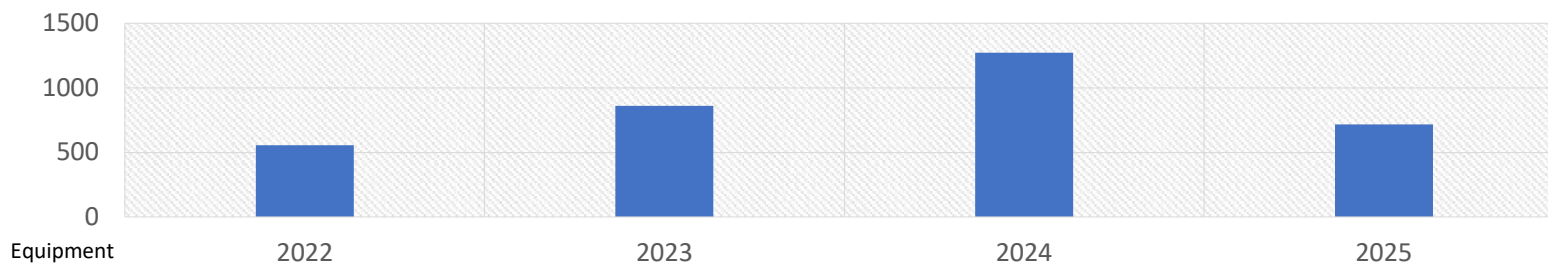
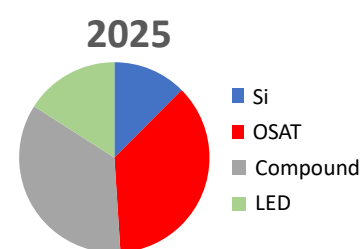
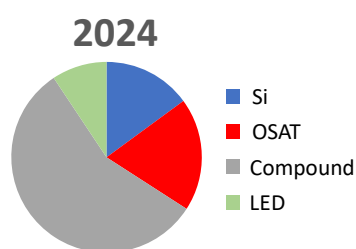
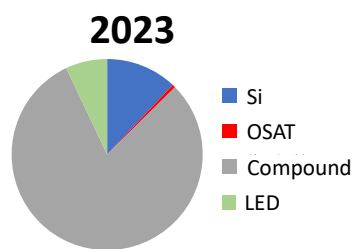
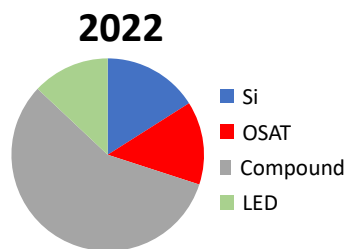
	2023	2024	2025 Q1	2025 Q2	2025 Q3	2025 Q4	2025	2026 Q1
Net Revenue	1,992,643	2,587,641	461,194	512,306	549,489	721,657	2,244,646	582,447
Gross Margin %	44.02%	43.96%	41.91%	39.21%	36.51%	42.29%	40.09%	41.77%
Net Income	306,661	406,803	49,033	18,875	59,887	72,000	199,795	61,756
EPS (NT\$)	5.02	6.03	0.73	0.28	0.91	1.09	3.01	0.96

Equipment - Product and Industry Distribution

Product Distribution

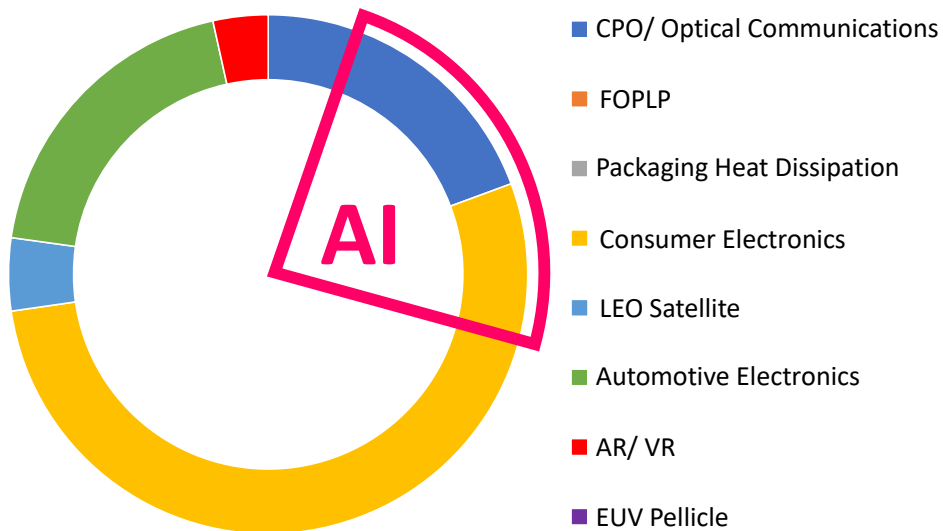


Industry Distribution

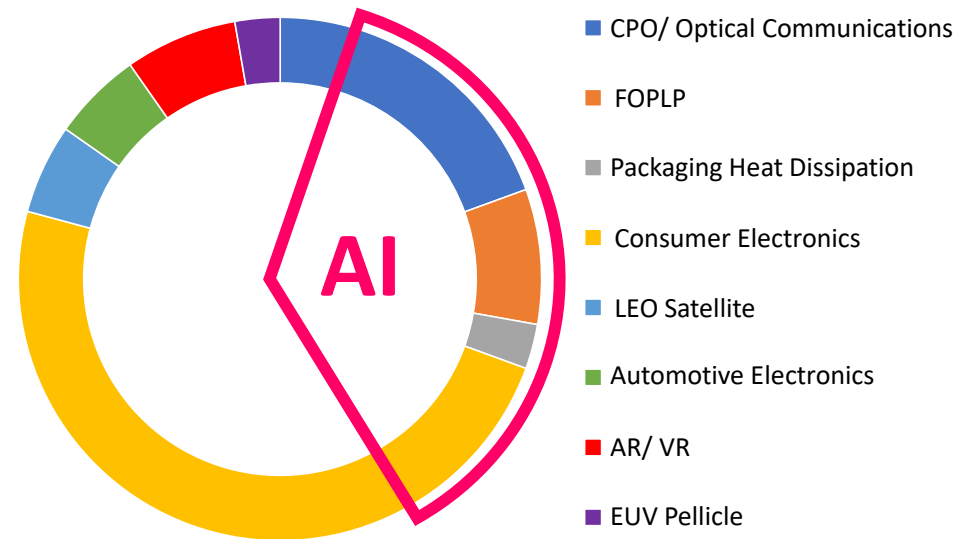


Equipment Shipping Status- based on Application

YR18~25 Accumulated



YR26/27 Guidance



Skytech 天虹科技

SkyEUV 輝虹科技

JTC 哲虹科技

鑫天虹
SKYSEMI



NEXDA

Shuxda

Panda

Wanda

Atomila

Bondela

Catapulta

Sgun